

January 7, 1998

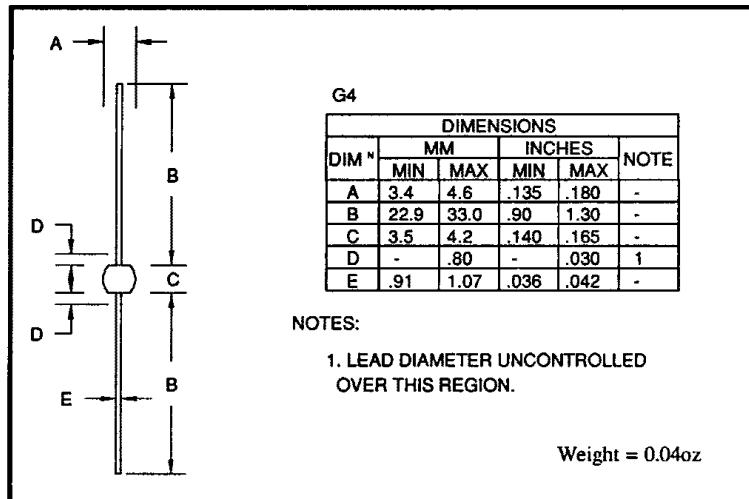
**AXIAL LEADED HERMETICALLY SEALED  
SUPERFAST RECTIFIER DIODE**
**QUICK  
REFERENCE DATA**

- Very low reverse recovery time
- Hermetically sealed with Metoxilite fused metal oxide
- Low thermal impedance
- Low switching losses
- Soft, non-snap off, recovery characteristics

- $V_R = 200 - 400V$
- $I_F = 5.0A$
- $t_{rr} = 50\text{nS}$
- $I_R = 20\mu\text{A}$

**ABSOLUTE MAXIMUM RATINGS (@ 25°C unless otherwise specified)**

	Symbol	USC1304	USC1305	USC1306	Unit
Working reverse voltage	$V_{RWM}$	200	300	400	V
Repetitive reverse voltage	$V_{RRM}$	200	300	400	V
Average forward current (@ 55°C, lead length = 0.375")	$I_{F(AV)}$	5.0	5.0	5.0	A
Repetitive surge current (@ 55°C in free air, lead length 0.375")	$I_{FRM}$	16	16	16	A
Non-repetitive surge current ( $t_p = 8.3\text{mS}$ , @ $V_R$ & $T_{jmax}$ )	$I_{FSM}$	70	70	70	A
Storage temperature range	$T_{STG}$	-55 to +150	-55 to +150	-55 to +150	°C
Operating temperature range	$T_{OP}$	-55 to +150	-55 to +150	-55 to +150	°C

**MECHANICAL**


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**ELECTRICAL CHARACTERISTICS (@ 25°C unless otherwise specified)**

	Symbol	USC1304	USC1305	USC1306	Unit
Average forward current max. (pcb mounted; $T_A = 55^\circ\text{C}$ ) for sine wave for square wave ( $d = 0.5$ )	$I_{F(AV)}$ $I_{F(AV)}$	2.9	3.0	2.9	A
Average forward current max. ( $T_L = 55^\circ\text{C}$ ; $L = 3/8"$ ) for sine wave for square wave	$I_{F(AV)}$ $I_{F(AV)}$	4.9	5.0	4.9	A
$I^2t$ for fusing ( $t = 8.3\text{mS}$ ) max.	$I^2t$	20	—	—	$\text{A}^2\text{s}$
Forward voltage drop max. @ $I_F = 3.0\text{A}$ , $T_j = 25^\circ\text{C}$	$V_F$	1.25	—	—	V
Reverse current max. @ $V_{RWM}$ , $T_j = 25^\circ\text{C}$ @ $V_{RWM}$ , $T_j = 100^\circ\text{C}$	$I_R$ $I_R$	20	500	—	$\mu\text{A}$
Reverse recovery time max. 0.5A $I_F$ to 1.0A $I_R$ . Recovers to 0.25A $I_{RR}$ .	$t_{rr}$	50	—	—	nS
Junction capacitance typ. @ $V_R = 10\text{V}$ , $f = 1\text{MHz}$	$C_J$	90	—	—	$\text{pF}$

**THERMAL CHARACTERISTICS**

	Symbol	USC1304	USC1305	USC1306	Unit
Thermal resistance - junction to lead Lead length = 0.375" Lead length = 0.0"	$R_{\theta JL}$ $R_{\theta JL}$	20	5	—	$^\circ\text{C}/\text{W}$
Thermal resistance - junction to amb. on 0.06" thick pcb. 1 oz. copper.	$R_{\theta JA}$	75	—	—	$^\circ\text{C}/\text{W}$